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PATENT APPLICATION

In re application of:

Jun Young Yang

Application No.

09/687,493

Filed:

October 13, 2000

For:

SSEMICONDUCTOR PACKAGE HAVING IMPROVED
ADHESIVENESS AND GROUND BONDING

Group No.

2811

Examiner:

(Not Yet Known)



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Assistant Commissioner for Patents
Washington, D.C. 20231

PRELIMINARY AMENDMENT
WITH REPLACEMENT SECTION UNDER RULE 1.121(b)

Applicant respectfully requests the Examiner to consider the following amendment and comments.